

MDT0350FOSC-PAR	320 x 240	Parallel Interface	TFT Module
(MCT035AB0CW320240LML)			
Specification			
Version: 1		Date: 12/03/2016	
Revision			
1	10/03/2016	First issue	

Display Features			
Display Size	3.5"		
Resolution	320 x 240		
Orientation	Landscape		
Appearance	RGB		
Logic Voltage	3.1V		
Interface	Parallel		
Brightness	250 cd/m ²		
Touchscreen	CTP		
Module Size	93.50 x 66.44 x 8.53mm		
Operating Temperature	-20°C ~ +70°C		
Pinout	36 Way Connector		
Pitch	---	Box Quantity	Weight / Display
		---	---

* - For full design functionality, please use this specification in conjunction with the SSD1963 specification.(Provided Separately)

Display Accessories	
Part Number	Description
MDIB-RPI	The MDIB-RPI is a Raspberry Pi interface board designed to provide connectivity and compatibility to a range of MIDAS TFT displays.
MCFFC36WA100-1963 MCFFC36WA50-1963	36 way 100mm FFC with 0.5mm pitch 36 way 50mm FFC with 0.5mm pitch

Optional Variants	
Appearances	Voltage

Summary

This technical specification applies to 3.45' color TFT-LCD panel. The 3.45' color TFT-LCD panel is designed for camcorder, digital camera application and other electronic products which require high quality flat panel displays. This module follows RoHS.

General Specifications

- Size: 3.5 inch
- Dot Matrix: 320 x RGBx240(TFT) dots
- Module dimension: 93.5 x 66.44 x 8.53 mm
- Active area: 70.08 x 52.56 mm
- Dot pitch: 0.073 x 0.219 mm
- LCD type: TFT, Normally White, Transmissive
- View Direction: 12 o'clock
- Gray Scale Inversion Direction: 6 o'clock
- Backlight Type: LED, Normally White
- Controller IC: SSD1963
- CTP FW Version: 0A
- Interface: Digital 8080 family MPU 8bit/16bit
- With /Without TP: With CTP
- Surface: Glare

*Color tone slight changed by temperature and driving voltage.



Interface

LCM PIN Definition (CON2)

Pin	Symbol	Function	Remark
1	GND	System ground pin of the IC. Connect to system ground.	
2	VDD	Power Supply : +3.3V	
3	BL_E	Backlight control signal , H: On \ L: Off	
4	D/C	Data/Command select	
5	WR	Write strobe signal	
6	RD	Read strobe signal	
7	DB0	Data bus	
8	DB1	Data bus	
9	DB2	Data bus	
10	DB3	Data bus	
11	DB4	Data bus	
12	DB5	Data bus	
13	DB6	Data bus	
14	DB7	Data bus	
15	DB8	Data bus (When select 8bits Mode, this pin is NC)	Note1
16	DB9	Data bus (When select 8bits Mode, this pin is NC)	Note1
17	DB10	Data bus (When select 8bits Mode, this pin is NC)	Note1
18	DB11	Data bus (When select 8bits Mode, this pin is NC)	Note1
19	DB12	Data bus (When select 8bits Mode, this pin is NC)	Note1
20	DB13	Data bus (When select 8bits Mode, this pin is NC)	Note1
21	DB14	Data bus (When select 8bits Mode, this pin is NC)	Note1
22	DB15	Data bus (When select 8bits Mode, this pin is NC)	Note1
23	NC	No connect	
24	CTP_INT	External interrupt to the host	

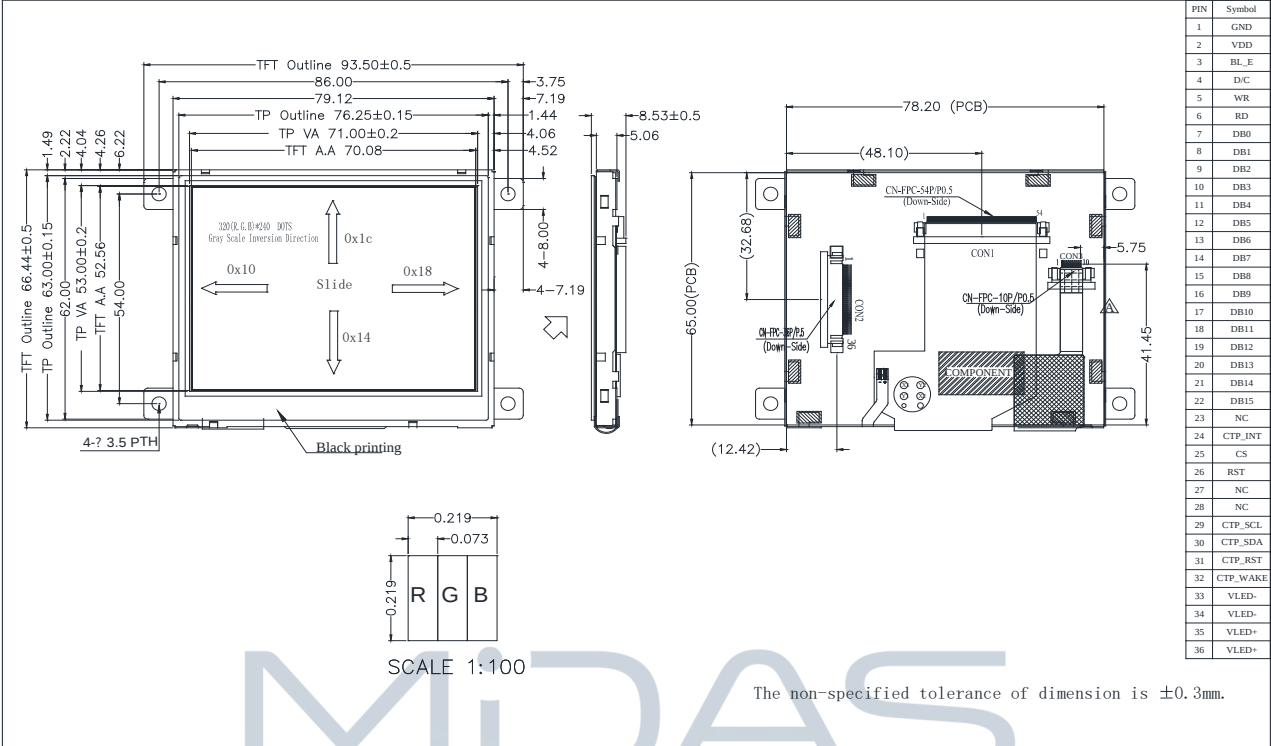
25	CS	Chip select	
26	RST	Hardware reset	
27	NC	No connect	
28	NC	No connect	
29	CTP_SCL	SPI Slave mode, chip select, active low I2C clock input	
30	CTP_SDA	SPI Slave mode, data input I2C data input and output	
31	CTP_RST	External Reset, Low is active	
32	CTP_WAKE	External interrupt from the host	
33	VLED-	VLED- for B/L LED inverter (GND)	
34	VLED-	VLED- for B/L LED inverter (GND)	
35	VLED+	VLED+ for B/L LED inverter (+3.3V)	
36	VLED+	VLED+ for B/L LED inverter (+3.3V)	

Note1: When select 8bit mode, DB0~DB7 be used, DB8~DB15 no connect
When select 16bit mode, DB0~DB15 be used

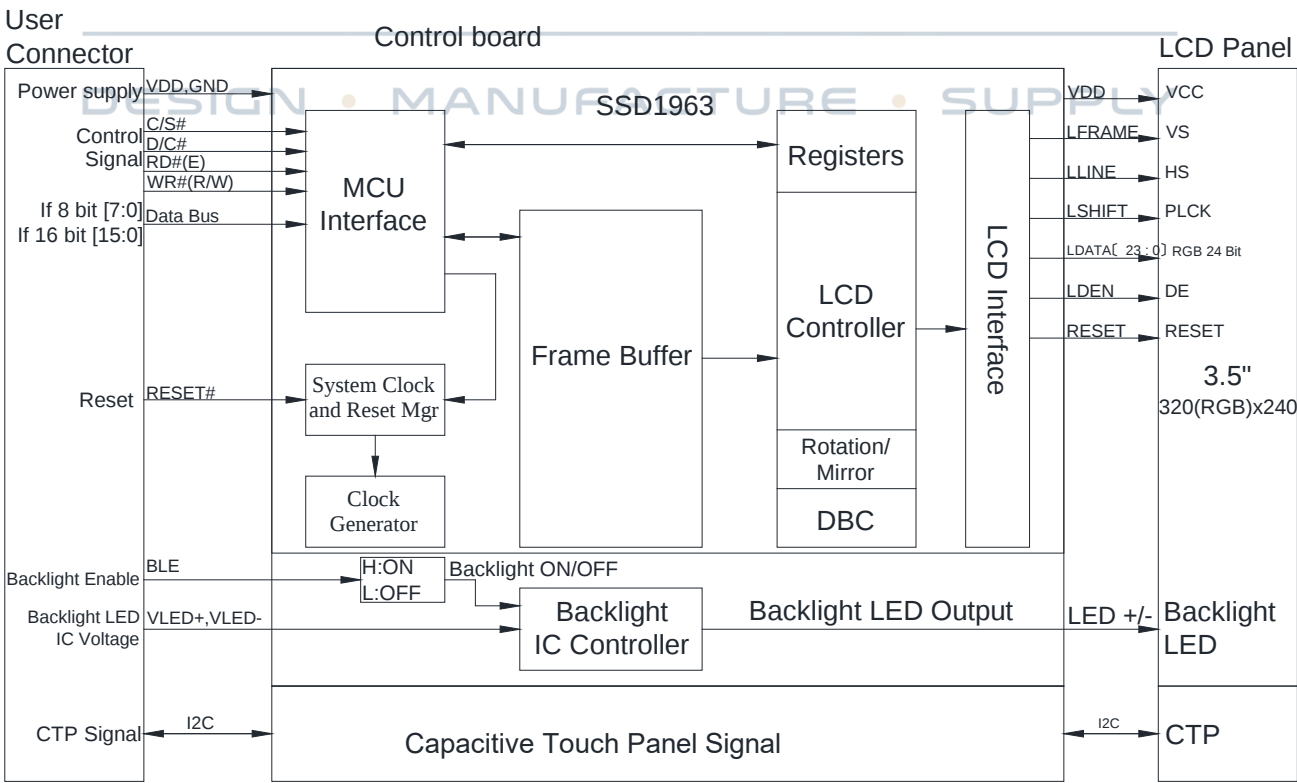
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Contour Drawing



Block Diagram

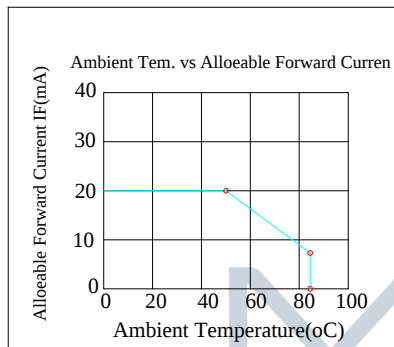


Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

- Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C



Electrical Characteristics

1. Operating conditions: (CON2.Pin1=GND, Pin2=VDD)

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Supply Voltage For LCM	VDD	—	3.0	3.1	3.3	V	-
Supply Current For LCM	IDD	—	—	210	350	mA	Note1

Note 1 : This value is test for VCC=3.1V , Ta=25°C only

2. Backlight driving conditions (CON2.Pin33,34=VLED-, Pin35,36=VLED+)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
Operation Current For LED Driver	VLED=3.3V	150	-	225	mA	Note 1,2
Power Consumption	VLED=3.3V	495	-	742.5	mW	Note 1,2
Supply Voltage For LED Driver	VLED+	3.3	-	5	V	-
LED Life Time		-	50,000	-	Hr	Note 2,3,4

Note 1 : Base on VLED= 3.3V for the back light driver IC specification

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

DC CHARATERISTICS

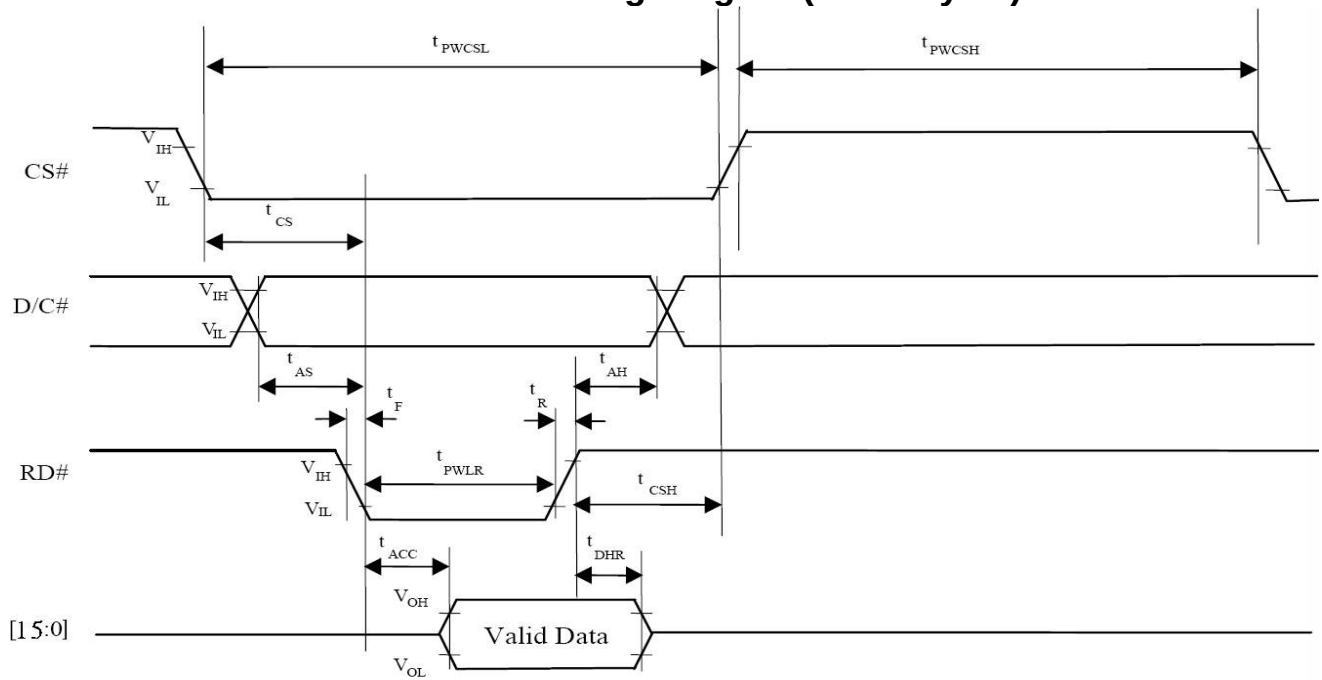
Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3VDD	V	
High level input voltage	V_{IH}	0.7VDD	-	VDD	V	



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Parallel 8080-series Interface Timing Diagram(Read Cycle)



Pixel Data Format

Interface	Cycle	D[15]	D[14]	D[13]	D[12]	D[11]	D[10]	D[9]	D[8]	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
16 bits (565 format)	1 st	R5	R4	R3	R2	R1	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1
16 bits	1 st	R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0
	2 nd	B7	B6	B5	B4	B3	B2	B1	B0	R7	R6	R5	R4	R3	R2	R1	R0
	3 rd	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
8 bits	1 st									R7	R6	R5	R4	R3	R2	R1	R0
	2 nd									G7	G6	G5	G4	G3	G2	G1	G0
	3 rd									B7	B6	B5	B4	B3	B2	B1	B0

Optical Characteristics

Item	Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time	Tr	$\theta=0^\circ$ 、 $\Phi=0^\circ$	-	10	-	ms	Note 3,5
	Tf		-	15	-	ms	
Contrast ratio	CR	At optimized viewing angle	300	350	-	-	Note 4,5
Color Chromaticity	White	$\theta=0^\circ$ 、 $\Phi=0^\circ$	0.25	0.30	0.35	-	Note 2,6,7
	Wy		0.27	0.32	0.37	-	-
Viewing angle (Gray Scale Inversion Direction)	Hor.	Θ_R	-	75	-	Deg.	Note 1
		Θ_L	-	75	-		
	Ver.	Φ_T	-	75	-		
		Φ_B	-	75	-		
Brightness	-	-	200	250	-	cd/m ²	Center of display

Ta=25±2°C, VLED /ILED = 3.3V /150mA

Note 1: Definition of viewing angle range

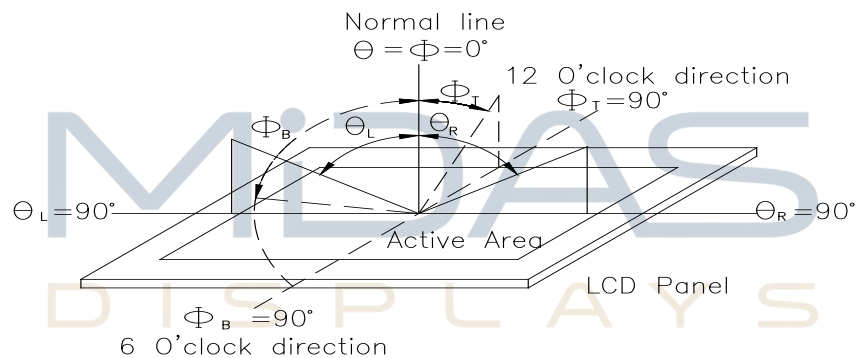


Fig. 11.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

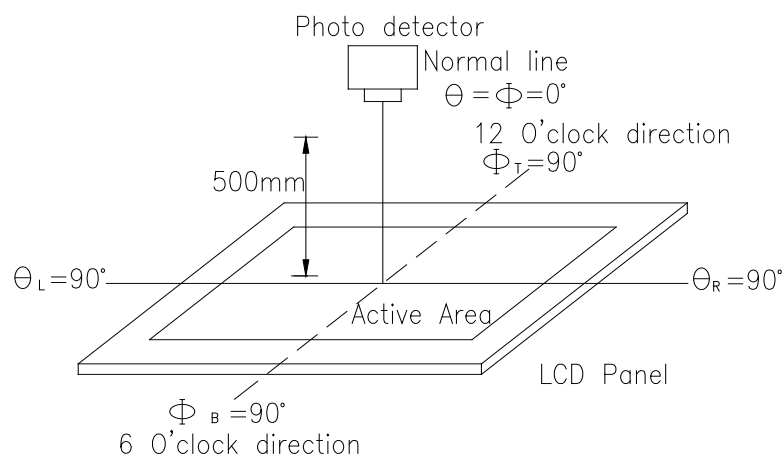
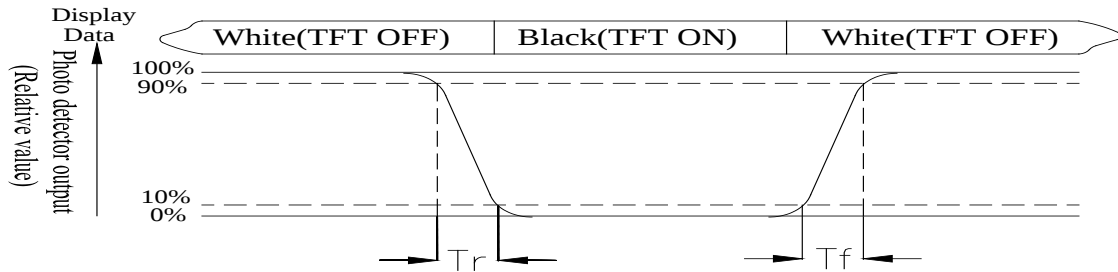


Fig. 11.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: White $V_i = V_{i50} \pm 1.5V$

Black $V_i = V_{i50} \pm 2.0V$

" $\pm$ " means that the analog input signal swings in phase with VCOM signal.

" $\pm$ " means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

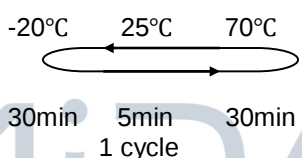
Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

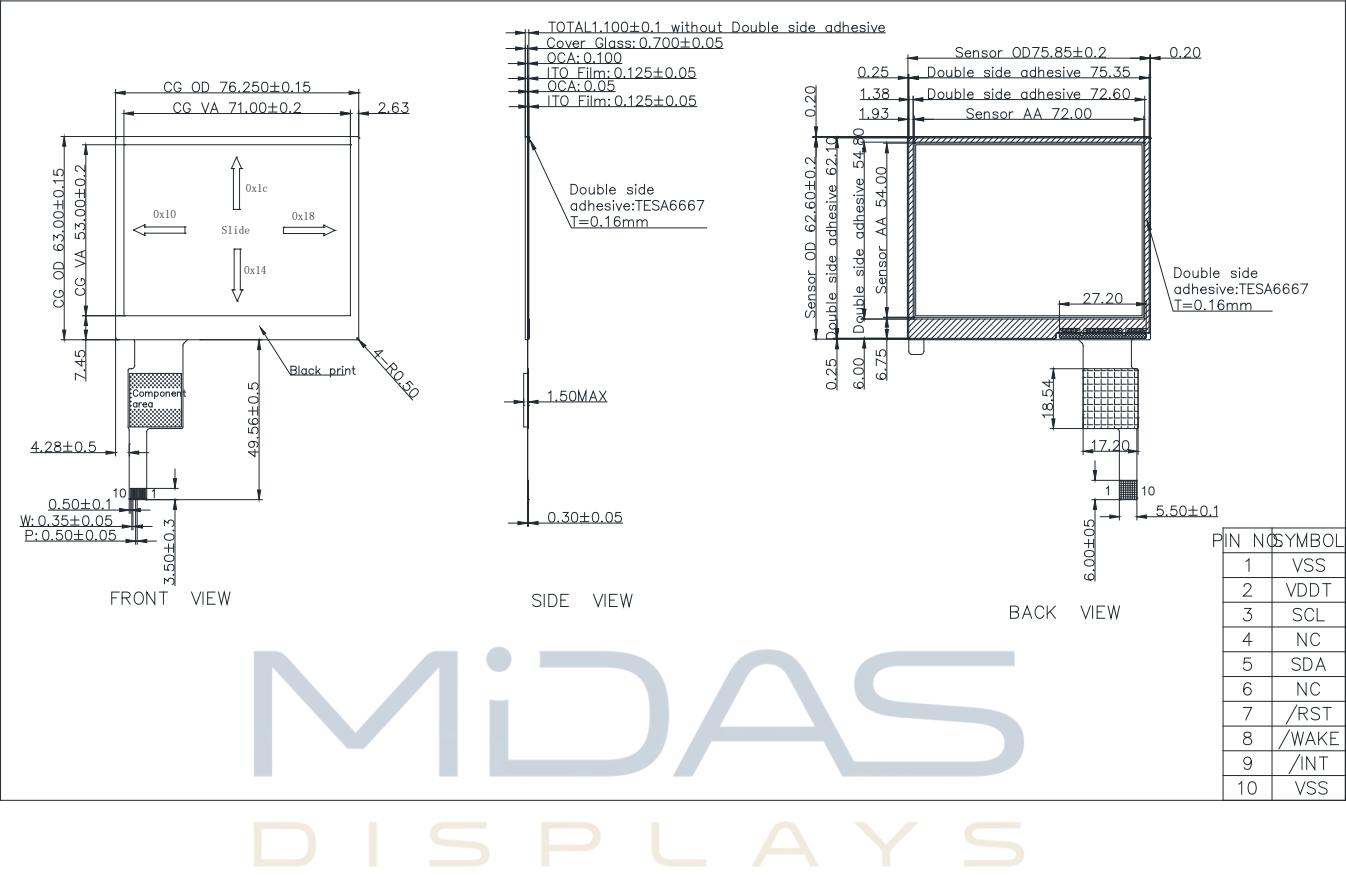
Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation 	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 3 15mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ,±800v(air), RS=330Ω CS=150pF 10 times	—

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

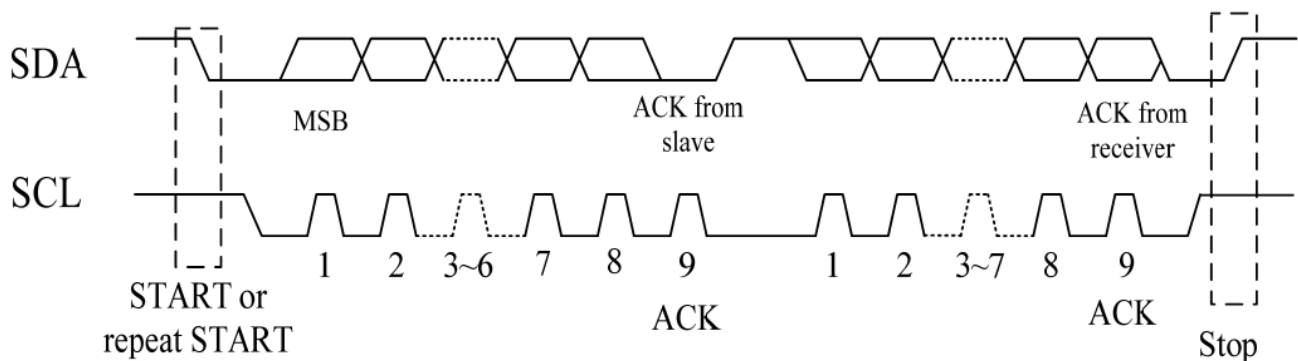
Note3: The packing have to including into the vibration testing.

Touch Panel Information

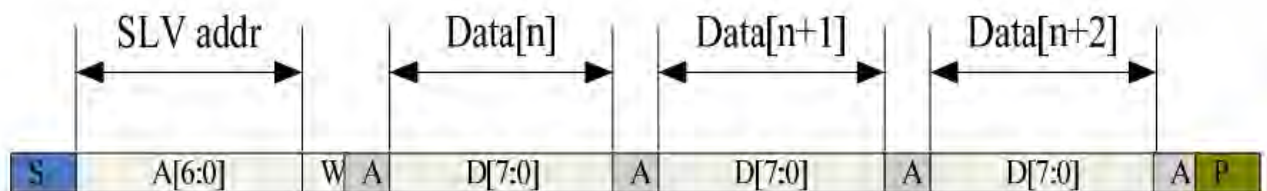


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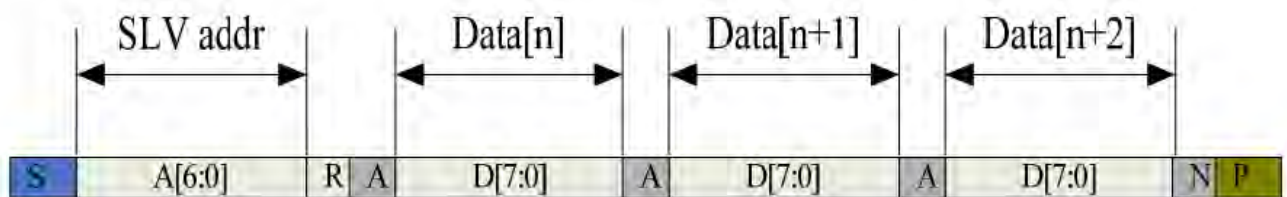
CTP I2C Timing:



I2C Serial Data Transfer Format



I2C master write, slave read



I2C master read, slave write

Mnemonics	Description
S	12C Start or 12C Restart
A[6:0]	Slave address A[6:4]:3'b011 A[3:0]:data bits are identical to those of 12CCON[7:4]register
W	1'b0:Write
R	1'b1:Read
A(N)	ACK(NACK)
P	STOP :the indication of the end of a packet(if this bit is missing, S will indicate the end of the current packet and beginning of the next packet)

Lists the meanings of the mnemonics used in the above figures

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400

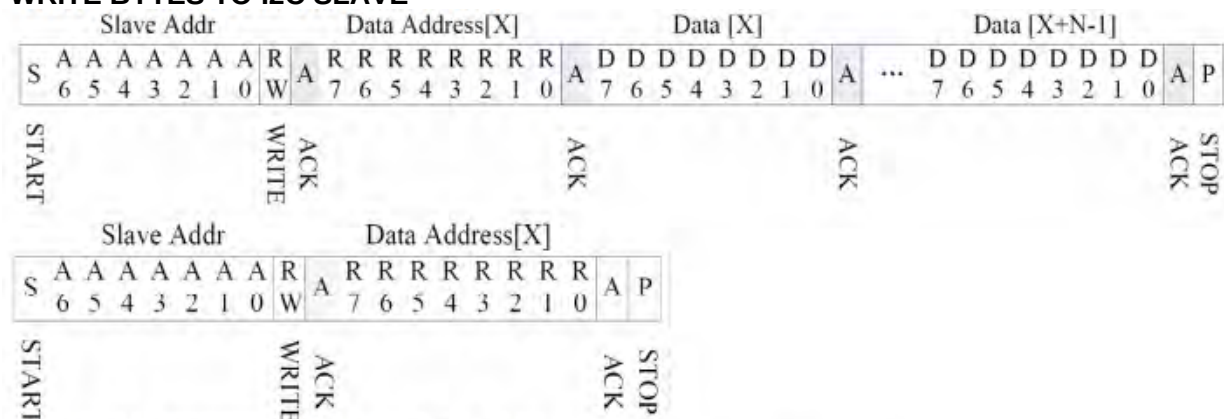
Bus free time between a STOP and START condition	us	4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup time for STOP condition	us	4.0	\

Interface Timing Characteristics

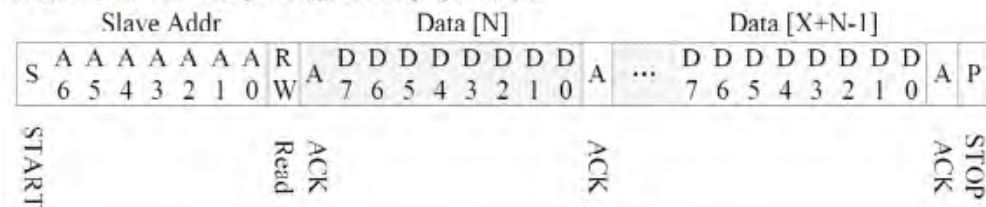
AS FOR STANDARD CTPM, HOST NEED TO USE BOTH INTERRUPT CONTROL SIGNAL AND SERIAL DATA INTERFACE TO GET THE TOUCH DATA.

HERE IS THE TIMING TO GET TOUCH DATA.

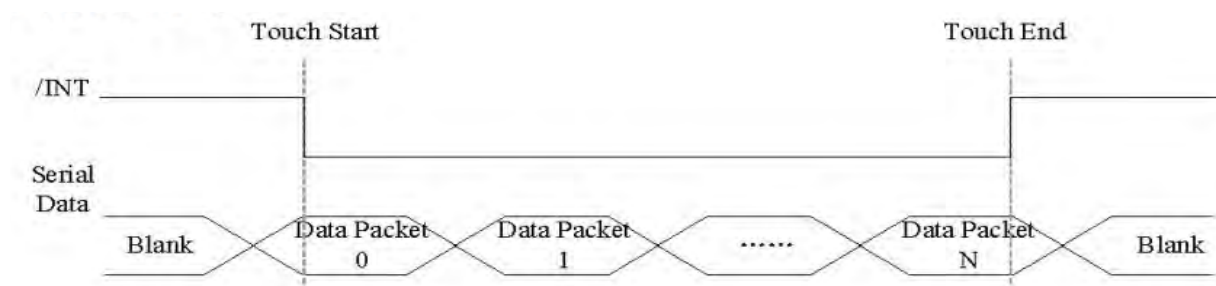
WRITE BYTES TO I2C SLAVE



READ X BYTES FROM I2C SLAVE



AS FOR STANDARD CTPM, HOST NEED TO USE BOTH INTERRUPT CONTROL SIGNAL AND SERIAL DATA INTERFACE TO GET THE TOUCH DATA, HERE IS THE TIMING TO GET TOUCH DATA.



Address: 0x38

TOUCH DATA READ PROTOCOL

NAME	VALUE	DESCRIPTION
START CH	0X00	START COMMAND FOR CTPM TOUCH DATA PACKET,HOST MUST SEND CTPM A START CH COMMAND BEFORE READ TOUCH DATA
1st READ BYTE~ LAST READ BYTE		TOUCH DATA PACKET SENT BY CTPM,EACH BYTE HAS 8-BIT DATA ,A TOUCH DATA PACKET CONSISTS OF N BYTE

A DATA PACKET STARTS WITH A HEADER AND ENDS WITH CRC CODE,AS FOR 5 POINTS DATA PACKET,THE LENGTH OF THE PACKET IS ALWAYS 26 BYTES IN SPITE OF ACTUAL TOUCH POINTS.

Address	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access
00h	Devide__Mode		Device Model[2:0]							RW
01h	Gest__ID	Gesture ID[7:0]								R
02h	TD__Status					Number of touch points[3:0]				R
03h	Touch1__XH	1 st Event Flag				1 st Touch X Position[11:8]				R
04h	Touch1__XL	1 st Touch X Position[7:0]								R
05h	Touch1__YH	1 st Touch ID[3:0]				1 st Touch Y Position[11:8]				R
06h	Touch1__YL	1 st Touch Y Position[7:0]								R
09h	Touch2__XH	2 nd Event Flag				2 nd Touch X Position[11:8]				R
0Ah	Touch2__XL	2 nd Touch X Position[7:0]								R
0Bh	Touch2__YH	2nd Touch ID[3:0]				2ndTouch Y Position[11:8]				R
0Ch	Touch2__YL	2nd Touch Y Position[7:0]								R

0Fh	Touch3__XH	3rdEvent Flag		3rdTouch X Position[11:8]	R
10h	Touch3__XL	3rd Touch X Position[7:0]			R
11h	Touch3__YH	3rdTouch ID[3:0]		3rdTouch Y Position[11:8]	R
12h	Touch3__YL	3rd Touch Y Position[7:0]			R
15h	Touch4__XH	4thEvent Flag		4thTouch X Position[11:8]	R
16h	Touch4__XL	4th Touch X Position[7:0]			R
17h	Touch4__YH	4thTouch ID[3:0]		4thTouch Y Position[11:8]	R
18h	Touch4__YL	4th Touch Y Position[7:0]			R
1Bh	Touch5__XH	5thEvent Flag		5thTouch X Position[11:8]	R
1Ch	Touch5__XL	5th Touch X Position[7:0]			R
1Dh	Touch5__YH	5thTouch ID[3:0]		5thTouch Y Position[11:8]	R
1Eh	Touch5__YL	5th Touch Y Position[7:0]			R

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Initial Code For Reference

```
void Initial_code()
{
    Unsigned int SOURCE,GATE;
    SOURCE=320;
    GATE=240;

    Reset = 1;
    Delay_ms(10);
    Reset = 0;
    Delay_ms(50);
    Reset = 1;
    Delay_ms(100);

    Write_Command(0x01);
    Delay_ms(10);
    Write_Command(0xe0);    //START PLL
    Write_Parameter(0x01);
    Delay_ms(50);
    Write_Command(0xe0);    //LOCK PLL
    Write_Parameter(0x03);
    Delay_ms(5);
    Write_Command(0xb0);
    Write_Parameter(0x2C);
    Write_Parameter(0x80);
    Write_Parameter((SOURCE-1)>>8);
    Write_Parameter(SOURCE-1);
    Write_Parameter((GATE-1)>>8);
    Write_Parameter(GATE-1);
    Write_Command(0xf0);
    Write_Parameter(0x03); //0x03 is 16bit(565 format);0x00 is for 8-bit,pixel data format
    //Set the MN of PLL
    Write_Command(0xe2);
    Write_Parameter(0x1d);
    Write_Parameter(0x02);
    Write_Parameter(0x54);
    Write_Command(0xe6);
    Write_Parameter(0x01);
    Write_Parameter(0xdd);
    Write_Parameter(0xde);
    //Set front porch and back porch
    Write_Command(0xb4);
    Write_Parameter(0x01);
    Write_Parameter(0x98);
    Write_Parameter(0x00);
    Write_Parameter(0x44);
    Write_Parameter(0x14);
    Write_Parameter(0x00);
    Write_Parameter(0x00);
}
```



```
Write_Parameter(0x00);
Write_Command(0xb6);
Write_Parameter(0x01);
Write_Parameter(0x06);
Write_Parameter(0x00);
Write_Parameter(0x12);
Write_Parameter(0x04);
Write_Parameter(0x00);
Write_Parameter(0x00);
Write_Command(0x2a);
Write_Parameter(0x00);
Write_Parameter(0x00);
Write_Parameter((SOURCE-1)>>8); /
Write_Parameter(SOURCE-1);
Write_Command(0x2b);
Write_Parameter(0x00);
Write_Parameter(0x00);
Write_Parameter((GATE-1)>>8);
Write_Parameter(GATE-1);
Write_Command(0x29);
Write_Command(0x2c);
}
```

MIDAS
DISPLAYS

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